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Project: Advancing Diffusion Bonding for Compact Heat

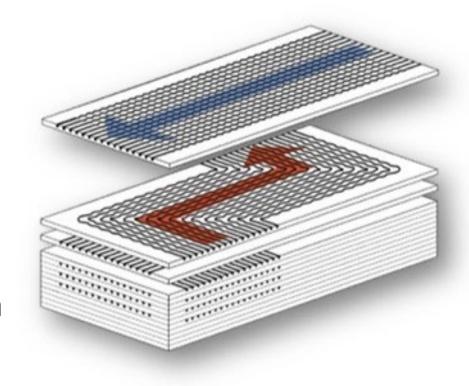
Exchangers

Advisor: Mark Anderson

Sponsor: Department of Energy



Compact heat exchangers have become an attractive addition to power cycles by reducing the material and space needed while improving efficiencies compared to a traditional heat exchanger. However, materials suited for high temperature and pressure environments have shown to have a reduction in material properties when diffusion bonded together. In order to incorporate diffusion bonded heat exchangers into the industry, a deeper understanding of the diffusion bonding process and its affect on the material properties must be known for the code cases.







Project Goals

- To analyze material properties and grain structures of diffusion bonded Ni-based Alloy 617 and Stainless Steel 316H.
- To produce wrought material properties from a diffusion bond by optimizing the diffusion bonding parameters such as pressure, dwell time, temperature, and surface finish through experimentation.
- Development of acceptance criteria for ASME BPVC Section III, Division 5 applications



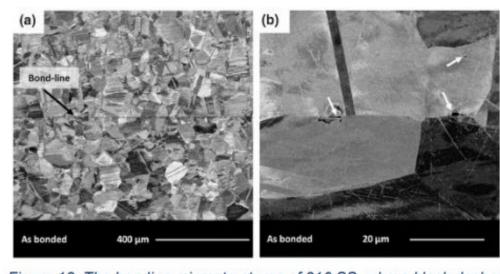


Figure 13: The bonding microstructures of 316 SS, where black dashed line indicates bond-line, while arrows denote Si/Al rich precipitates.

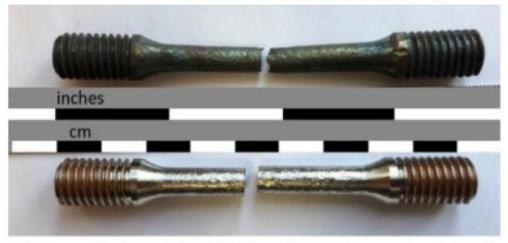


Figure 11: Alloy 617 diffusion- bonded samples tested at room temperature (bottom) and 750°C (Top)